

RoHS Available on commercial versions	VOIDLESS HERMETICAL RECOVERY GLA Qualified to MIL	SS RECT	IFIERS	DARD	<u>Qualified Levels</u> : JAN, JANTX, JANTXV and JANS
This "standard applications w rectifiers for w with voidless-g devices are als offers numero recovery time hole and surfa					
Important: For th					
 JEDEC reg Voidless he Extremely r Quadruple- 					
 Internal "Ca JAN, JANT RoHS com 	"B" Package				
	Also available in:				
 Standard re Military and General red High forwar Low thermatic Controlled Extremely reinformed in the control in the	"B" SQ-MELF (D-5B) Package (surface mount) 1N5550US – 1N5554US				
	MAXIMUM RATINGS @ $T_A = 25 °C$	unless otherwi	se noted.		
Devenuetors	Fact Conditions	Cumela al	Value	llmit	
	Test Conditions Storage Temperature	Symbol T _J and T _{STG}	Value -65 to +175	Unit ℃	
	stance Junction-to-Lead ⁽¹⁾		22	°C/W	
	edance @ 10 ms heating time	Z _{ØJX}	1.5	°C/W	MSC – Lawrence 6 Lake Street,
	rward Surge Current (8.3 ms half sine)	I _{FSM}	100	Α	Lawrence, MA 01841
Average Rec	tified Forward Current ⁽¹⁾ @ $T_L = 30 \degree C$	I _{O(L)}	5	А	Tel: 1-800-446-1158 or
	tified Forward Current $^{(3)}$ @ T _A = 55 $^{\circ}$ C	I _{O2} ⁽²⁾	3	А	(978) 620-2600 Fax: (978) 689-0803
	@ T _A = 100 °C	I ₀₃ ⁽⁴⁾	2	A	
Working Pea	k Reverse Voltage 1N5550	V _{RWM}	200	V	MSC – Ireland
	1N5551		400		Gort Road Business Park, Ennis, Co. Clare, Ireland
	1N5552		600		Tel: +353 (0) 65 6840044
	1N5553 1N5554		800 1000		Fax: +353 (0) 65 6822298
Solder Temp	erature @ 10 s	T _{SP}	260	°C	Website:
<u> </u>		1 · 24	200		www.microsemi.com
See notes on ne	kt page.				



MAXIMUM RATINGS

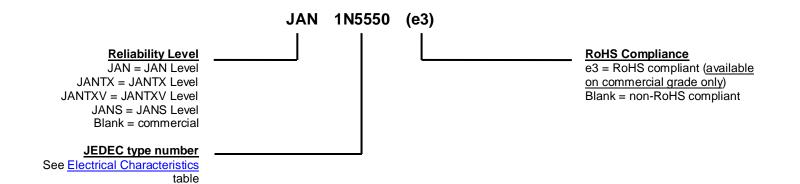
Notes: 1. At .375 inch (9.52 mm) lead length from body.

- 2. Derate linearly at 22.2 mA/°C from +55 °C to +100 °C.
 - 3. These I_O ratings are for a thermally (PC boards or other) mounting methods where the lead or end-cap temperatures cannot be maintained and where thermal resistance from mounting point to ambient is still sufficiently controlled where $T_{J(MAX)}$ does not exceed 175 °C. This equates to $R_{\theta JX} \le 47$ °C/W.
 - 4. Derate linearly at 26.7 mA/°C above T_A = +100 °C to +175 °C ambient.

MECHANICAL and PACKAGING

- CASE: Hermetically sealed voidless hard glass with tungsten slugs.
- TERMINALS: Axial-leads are tin/lead (Sn/Pb) over copper. RoHS compliant matte-tin is available for commercial only.
- MARKING: Body paint and part number.
- POLARITY: Cathode band.
- TAPE & REEL option: Standard per EIA-296. Consult factory for quantities.
- WEIGHT: 750 milligrams.
- See Package Dimensions on last page.

PART NOMENCLATURE



SYMBOLS & DEFINITIONS						
Symbol	Definition					
V _{BR}	Minimum Breakdown Voltage: The minimum voltage the device will exhibit at a specified current.					
V _{RWM}	Working Peak Reverse Voltage: The maximum peak voltage that can be applied over the operating temperature range excluding all transient voltages (ref JESD282-B).					
Ιo	Average Rectified Output Current: The Output Current averaged over a full cycle with a 50 Hz or 60 Hz sine-wave input and a 180 degree conduction angle.					
VF	Maximum Forward Voltage: The maximum forward voltage the device will exhibit at a specified current.					
I _R	Maximum Reverse Current: The maximum reverse (leakage) current that will flow at the specified voltage and temperature.					
trr	Reverse Recovery Time: The time interval between the instant the current passes through zero when changing from the forward direction to the reverse direction and a specified decay point after a peak reverse current occurs.					



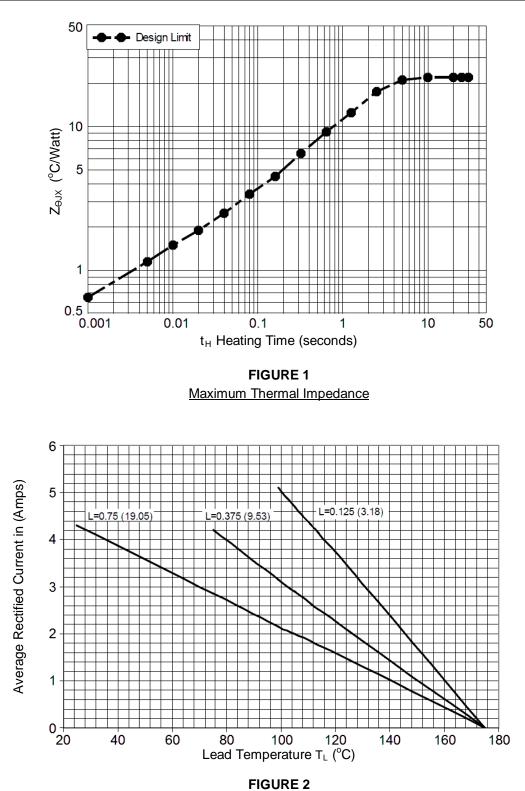
ТҮРЕ	MINIMUM BREAKDOWN VOLTAGE V _{BR}	FORWARD VOLTAGE V _F @ I _F = 9 A (pk)		MAXIMUM REVERSE CURRENT I _R @ V _{RWM}	REVERSE RECOVERY t _{rr}
	ν _{BR} I _R @ 50 μΑ Volts	MIN. Volts	MAX. Volts	и _к @ V _{кwм} μА	(Note 1) μs
1N5550	220	0.6 V (pk)	1.2 V (pk)	1.0	2.0
1N5551	440	0.6 V (pk)	1.2 V (pk)	1.0	2.0
1N5552	660	0.6 V (pk)	1.2 V (pk)	1.0	2.0
1N5553	880	0.6 V (pk)	1.3 V (pk)	1.0	2.0
1N5554	1100	0.6 V (pk)	1.3 V (pk)	1.0	2.0

ELECTRICAL CHARACTERISTICS @ T_A = 25 °C unless otherwise noted.

NOTE 1: I_F = 0.5 A, I_{RM} = 1.0 A, $I_{R(REC)}$ = .250 A.



GRAPHS



Maximum Current vs. Lead Temperature

NOTES: 1. Dimensions are in inches.

2. Metric equivalents (to the nearest .01 mm) are given for general information only and are based upon 1 inch = 25.4 mm.



GRAPHS (continued)

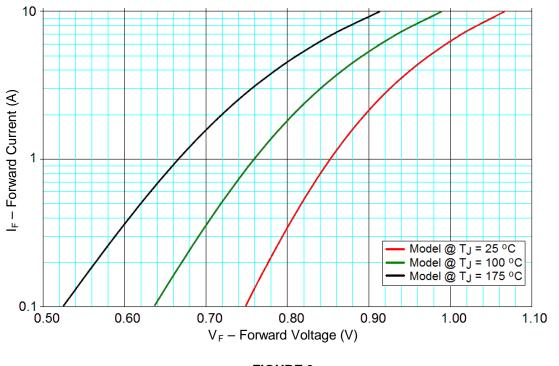
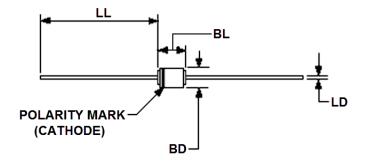


FIGURE 3 Typical Forward Voltage vs. Forward Current



PACKAGE DIMENSIONS



Ltr	Inch		Millim	Notes	
	Min	Max	Min	Max	
BD	0.115	0.180	2.92	4.57	3, 4
BL	0.130	0.300	3.30	7.62	4
LD	0.036	0.042	0.92	1.07	
LL	0.900	1.300	22.86	33.02	

NOTES:

- 1. Dimensions are in inches.
- 2. Millimeter equivalents are given for general information only.
- 3. The BL dimension shall include the entire body including slugs and sections of the lead over which the diameter is uncontrolled. This uncontrolled area is defined as the zone between the edge of the diode body and extending .050 inch (1.27 mm) onto the leads.
- 4. Dimension BD shall be measured at the largest diameter.
- 5. In accordance with ASME Y14.5M, diameters are equivalent to Φx symbology.